

# **SPECIFICATION SHEET**

SPECIFICATION SHEET NO.	Q0501-CG32M00000S001
DATE	May 01, 2023
REVISION	A0
DESCRIPITION	SMD Ceramic Resonator, 3731 Type, L3.7*W3.1*H1.2mm,
	Without Built-in Capacitance, 2 pads, CRAV Series
	32.000MHz, Frequency Accuracy +/-0.5%,
	Operating Temp. Range -25°C ~+85°C,
	Reflow Profile Condition 260 °C Max.
	RoHS/RoHS III compliant, Tape/Reel
CUSTOMER	
CUSTOMER PART NUMBER	
CROSS REF. PART NUMBER	
ORIGINAL PART NUMBER	TGS CRAV 32.0MX TLF
PART CODE	CG32M00000S001

VENDOR APPROVE			
Issued/Checked/Approved	Component Mandy E Transformer	Compose Ruby Chang Compose Com	Low Parent
DATE: May 01, 2023			
CUSTOMER APPROVE			

DATE:

5/1/2023

1

### 5/1/2023

# PART CODE: CG32M00000S001

# **SMD CERAMIC RESONATOR CRAV SERIES**

## MAIN FEATURE

- SMD Ceramic Resonator, L3.7\*W3.1\*H1.2mm, 2 pads
- Low cost & Without Built-in Capacitance
- Reflow Profile Condition 260 °C Max.
- Wide Frequency Range
- Cross more competitors part
- RoHS III compliant

## **APPLICATION**

- Bluetooth, wireless communication set
- Communication Electronics

# PART CODE GUIDE

CG	32M00000	S	001
1	2	3	4

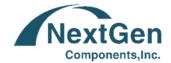
1) CG: Part family Code for SMD Ceramic Resonator, L3.7\*W3.1\*H1.2mm, 2 pads, CRAV series

2) 32M00000: Frequency range code for 32.00000MHz

3) S: SMD type, Package Tape/Reel, 1000pcs/Reel

4) 001: Specification code for original part No.: TGS CRAV 32.0MX TLF









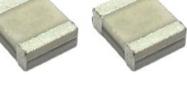


SMD CERAMIC RESONATOR CRAV SERIES

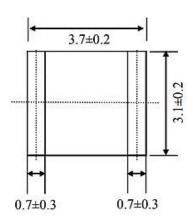
## **DIMENSION (Unit: mm)**



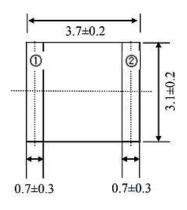
Image for reference







Marking Line 1: Freq. Range+ QC Code (A~Z)



2±0. 3.7±0.2

### Connection

#1 In/Output #2 Output/Input

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# **SMD CERAMIC RESONATOR CRAV SERIES**

### **ELECTRICAL PARAMETERS**

Parame	ter	Part No. Symbol	Units	Units Value		Condition	
		-		Min.	Typical	Max.	
Original	Manufacturer	TGS		TGS	Crystals		
Holder 1	Гуре	CRAV	SMD Ceram	nic Resonator,	L3.7*W3.1*H1.2m	nm, 2 pads	
Frequen	icy Range	32.0	MHz		32.000		
Withsta	nding Voltage		V	50			@DC, 1 min
Insulatio	on Resistance		MΩ	500			@AV, 1 min.
Operatio	on Temperance		°C	-25		+85	
Storage	Temperance		°C	-55		+85	
Rating V	/oltage		V		6.0		DC
					15		р-р
Frequen	icy Accuracy		%	% 0.5			
Resonar	nt Impedance		Ω			40	
Tempera of Oscill Frequen			%			+/-0.3	Oscillation Frequency drift, -25°C ~ +85°C)
	on Frequency ate (10 years)		%			+/-0.3	From initial value
IC applic	cation		1/6TC4069UBP				
Design I	Mode	MX					
Built-in	Capacitance		pF		N/A		
	Package	Т		Тар	pe/Reel		
	RoHS Status	LF	RoHS III compliant				
Other	Add Value		N/A				
	Internal Control Code <mark>*</mark>				N/A		

Note: 1) Original Part Number: TGS CRAV 32.0MX TLF

2) \* Internal Control Code- 2 letter or digits; Blank: N/A



# SMD CERAMIC RESONATOR CRAV SERIES

### RELIABILITY

Test Items	Test Method And Conditions	Performance Requirements
Humidity	Keep the resonator at 40°C±2°C and 90%-95% RH for 96h. Then Release the resonator into the room Condition for 1h prior to the Measurement.	It shall fulfill the specifications in Table 1.
High Temperature Exposure	Subject the resonator to -85°C±2°C for 96h, then release the resonator into the room conditions for 1h prior to the measurement.	It shall fulfill the specifications in Table 1.
Low Temperature Exposure	Subject the resonator to -55°C $\pm$ 2°C for 96h, then release the resonator into the room conditions for 1h prior to the measurement.	It shall fulfill the specifications in Table 1.
Temperature Cycling	After temperature cycling of blow table was performed 5 times, resonator shall be measured after being placed in natural conditions for 1h. Time: 30 min.@ -25 +/-3°C ; Time: 30 min. @85 +/-3°C	It shall fulfill the specifications in Table 1.
Vibration	Subject the resonator to vibration for 2h each in x, y and z axis With the amplitude of 1.5mm, the frequency shall be varied uniformly between the limits of 10 Hz—55Hz.	It shall fulfill the specifications in Table 1.
Mechanical Shock	Drop the resonator randomly onto a wooden floor from the height of 100cm 3 times.	It shall fulfill the specifications in Table 1.
Soldering Test	Passed through the re-flow oven under the following condition and left at room temperature for 1h before measurement	It shall fulfill the specifications in Table 1.
Solder Ability	Dipped in 245°C±5°C solder bath for 3s±0.5 s with rosin flux (25wt% ethanol solution.)	The terminals shall be at least 95% covered by solder.
Board Bending	Mount a glass-epoxy board (Width=40mm,thickness=1.6mm),then bend it to 1mm displacement and keep it for 5s. (See the following figure 1)	Mechanical damage such as breaks shall not occur.

#### Table 1

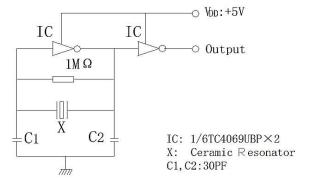
Item	Specification after test	
Oscillation Frequency Change $\triangle$ Fosc/Fosc (%) max	±0.3	
Resonant Impedance (Ω) max	40	
The limits in the above table are referenced to the initial measurements.		

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**SMD CERAMIC RESONATOR CRAV SERIES** 

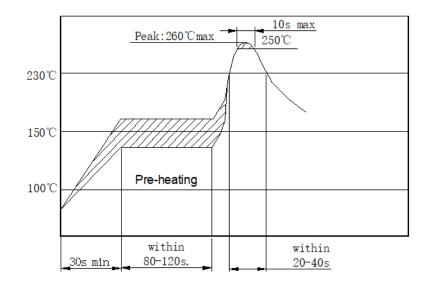
## **TEST CIRCUIT (For Reference Only)**



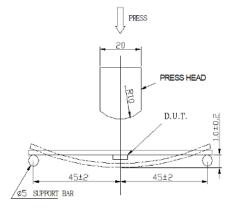
#### Note:

Parts shall be tested under the condition (Temp.: 20±15°C,Humidity 65±20% R.H.) unless the standard condition(Temp.: 25±3 °C, Humidity :65±10% R.H.) is regulated to measure.

### SUGGESTED REFLOW PROFILE (For Reference Only)



### **BOARD BENDING TEST- FIGURE 1**



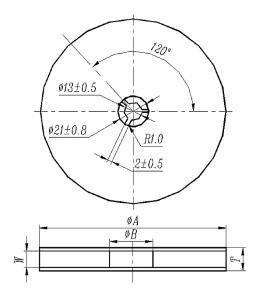
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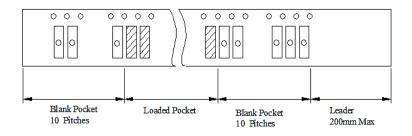
**SMD CERAMIC RESONATOR CRAV SERIES** 

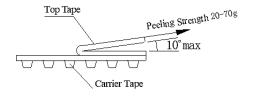
## TAPE/REEL (Unit: mm)

All Devices are packed in accordance with EIA standard RS-481-2 and specifications., 1000pcs/Reel



Symbol	Dimension
φA	180±3.0
фВ	60.0 Min.
W	12.4 Min.
Т	19.4 Max.





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